506720552 06/17/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6767370

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KABIR MIRPURI	06/16/2021

RECEIVING PARTY DATA

Name:	NXP USA, INC.
Street Address:	6501 WILLIAM CANNON DRIVE WEST
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17350190

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: Tracy.Buffett@nxp.com

Correspondent Name: NXP USA, INC.

Address Line 1: 6501 WILLIAM CANNON DRIVE WEST

Address Line 4: AUSTIN, TEXAS 78735

ATTORNEY DOCKET NUMBER:	82277585US01
NAME OF SUBMITTER:	TRACY BUFFETT
SIGNATURE:	/Tracy Buffett/
DATE SIGNED:	06/17/2021

Total Attachments: 1

source=82277585US01-ASSIGNMENT-Signed#page1.tif

PATENT 506720552 REEL: 056573 FRAME: 0284

SOLE ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, as a below-named Assignor, hereby sell, assign, and transfer the entire and exclusive right, title, and interest in the following to **NXP USA, INC.**, having a place of business at 6501 West William Cannon Drive, Austin, TX 78735, USA, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

(1) my invention relating to "SEMICONDUCTOR DEVICE PACKAGE CONNECTOR STRUCTURE AND METHOD THEREFOR" for which the following patent application(s) has/have been filed (I hereby authorize and request my/our attorneys associated with U.S. Patent & Trademark Office Customer Number 23125 to insert below the filing date and application number of the U.S. application when known):

<u>Country</u>	Application No.	Filing Date (mm/dd/yyyy)	Claims Priority of
US	17350190	06/17/2021	

- (2) the foregoing application(s) and all other United States, foreign and international patent applications associated therewith, based thereon, or claiming priority there from including, but not limited to, any and all provisionals, non-provisionals, divisions, continuations, continuations-in-part, re-examinations, reissues, and extensions thereof, and
- (3) the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

I authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to **NXP USA, INC.,** for its sole use, and that of its successors, assigns, and legal representatives.

I will provide my cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, I agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutional actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

I certify that I have the full right to convey the above rights.

 \mathcal{M}

16 June 2021	fmiret wu	, Assignor
Date	Kabir Mirpuri	

PATENT
RECORDED: 06/17/2021 REEL: 056573 FRAME: 0285